

Soldering acid

Preparation intended for soldering poorly solderable nickel-plated surfaces (ISO 9454 typ 3311 / J-STD-004 INMO).

Physicochemical properties			
Color	colorless		
Density at 20°C	1,2 g/cm ³		
Viscosity in 20°C	10 cP		
pH	<1		
Odour	No unpleasant smell		
Solubility in water	unlimited		
Content of non-volatile substances	min. 28 %		

Instructions for use:

Apply the preparation in a small amount to the solder element. Immediately after soldering, it should be washed with demineralized water.

Application:

nickel-plated surfaces

Packagings:

Volume	Type of packaging	Collective packaging	ltem Code
35ml	plastic bottle	20	ART.AGT-117
50ml	plastic bottle with brush	8	ART.AGT-253
100ml	plastic bottle	16	ART.AGT-246
100ml	plastic bottle with brush	8	ART.AGT-319
500ml	plastic bottle	1	ART.AGT-272
1 L	plastic bottle	1	ART.AGT-271

Warehousing:

Store the formulation in the original packaging provided by the manufacturer in dry, ventilated facilities protected against sunlight at 5-25 °C. Do not transfer to metal packagings. Do not store in open packagings along with alkaline products.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.